

**OptiMOS™3 M-Series Power-MOSFET**
**Features**

- Optimized for 5V driver application (Notebook, VGA, POL)
- Low FOM<sub>SW</sub> for High Frequency SMPS
- 100% avalanche tested
- N-channel
- Very low on-resistance  $R_{DS(on)}$  @  $V_{GS}=4.5\text{ V}$
- Excellent gate charge x  $R_{DS(on)}$  product (FOM)
- Qualified according to JEDEC<sup>1)</sup> for target applications
- Superior thermal resistance
- Pb-free plating; RoHS compliant
- Halogen-free according to IEC61249-2-21

**Product Summary**

|                  |                       |      |    |
|------------------|-----------------------|------|----|
| $V_{DS}$         |                       | 30   | V  |
| $R_{DS(on),max}$ | $V_{GS}=10\text{ V}$  | 11.5 | mΩ |
|                  | $V_{GS}=4.5\text{ V}$ | 15   |    |
| $I_D$            |                       | 35   | A  |

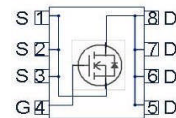
PG-TSDSON-8



RoHS



Halogen-Free



| Type          | Package     | Marking |
|---------------|-------------|---------|
| BSZ130N03MS G | PG-TSDSON-8 | 130N03M |

**Maximum ratings, at  $T_J=25\text{ °C}$ , unless otherwise specified**

| Parameter                                     | Symbol        | Conditions   | Value | Unit |
|---|---------------|--|-------|------|
| Continuous drain current                      | $I_D$         | $V_{GS}=10\text{ V}, T_C=25\text{ °C}$                             | 35    | A    |
|   |               | $V_{GS}=10\text{ V}, T_C=100\text{ °C}$                            | 22    |      |
|   |               | $V_{GS}=4.5\text{ V}, T_C=25\text{ °C}$                            | 31    |      |
|   |               | $V_{GS}=4.5\text{ V}, T_C=100\text{ °C}$                           | 19    |      |
|   |               | $V_{GS}=4.5\text{ V}, T_A=25\text{ °C}, R_{thJA}=60\text{ K/W}^2)$ | 9     |      |
| Pulsed drain current <sup>3)</sup>            | $I_{D,pulse}$ | $T_C=25\text{ °C}$   | 140   |      |
| Avalanche current, single pulse <sup>4)</sup> | $I_{AS}$      | $T_C=25\text{ °C}$   | 20    |      |
| Avalanche energy, single pulse                | $E_{AS}$      | $I_D=20\text{ A}, R_{GS}=25\text{ Ω}$                              | 9     | mJ   |
| Gate source voltage                           | $V_{GS}$      |  | ±20   | V    |

<sup>1)</sup> J-STD20 and JESD22

Maximum ratings, at  $T_j=25\text{ °C}$ , unless otherwise specified

| Parameter                           | Symbol                | Conditions   | Value       | Unit |
|-------------------------------------|-----------------------|--|-------------|------|
| Power dissipation                   | $P_{\text{tot}}$      | $T_C=25\text{ °C}$   | 25          | W    |
|                                     |                       | $T_A=25\text{ °C}$ ,<br>$R_{\text{thJA}}=60\text{ K/W}^2)$ | 2.1         |      |
| Operating and storage temperature   | $T_j, T_{\text{stg}}$ |  | -55 ... 150 | °C   |
| IEC climatic category; DIN IEC 68-1 |                       |  | 55/150/56   |      |

| Parameter | Symbol | Conditions | Values |      |      | Unit |
|-----------|--------|------------|--------|------|------|------|
|           |        |            | min.   | typ. | max. |      |

#### Thermal characteristics

|                                     |                   |  |   |   |    |     |
|-------------------------------------|-------------------|--|---|---|----|-----|
| Thermal resistance, junction - case | $R_{\text{thJC}}$ |  | - | - | 5  | K/W |
| Device on PCB                       | $R_{\text{thJA}}$ | 6 cm <sup>2</sup> cooling area <sup>2)</sup> | - | - | 60 |     |

Electrical characteristics, at  $T_j=25\text{ °C}$ , unless otherwise specified

#### Static characteristics

|                                  |                             |   |     |      |      |                  |
|----------------------------------|-----------------------------|---|-----|------|------|------------------|
| Drain-source breakdown voltage   | $V_{(\text{BR})\text{DSS}}$ | $V_{\text{GS}}=0\text{ V}, I_{\text{D}}=1\text{ mA}$                            | 30  | -    | -    | V                |
| Gate threshold voltage           | $V_{\text{GS(th)}}$         | $V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\text{ }\mu\text{A}$              | 1   | -    | 2    |                  |
| Zero gate voltage drain current  | $I_{\text{DSS}}$            | $V_{\text{DS}}=30\text{ V}, V_{\text{GS}}=0\text{ V}, T_j=25\text{ °C}$         | -   | 0.1  | 1    | $\mu\text{A}$    |
|                                  |                             | $V_{\text{DS}}=30\text{ V}, V_{\text{GS}}=0\text{ V}, T_j=125\text{ °C}$        | -   | 10   | 100  |                  |
| Gate-source leakage current      | $I_{\text{GSS}}$            | $V_{\text{GS}}=16\text{ V}, V_{\text{DS}}=0\text{ V}$                           | -   | 10   | 100  | nA               |
| Drain-source on-state resistance | $R_{\text{DS(on)}}$         | $V_{\text{GS}}=4.5\text{ V}, I_{\text{D}}=20\text{ A}$                          | -   | 12.4 | 15.0 | $\text{m}\Omega$ |
|                                  |                             | $V_{\text{GS}}=10\text{ V}, I_{\text{D}}=20\text{ A}$                           | -   | 9.2  | 11.5 |                  |
| Gate resistance                  | $R_{\text{G}}$              |   | 0.5 | 1.1  | 1.9  | $\Omega$         |
| Transconductance                 | $g_{\text{fs}}$             | $ V_{\text{DS}} >2 I_{\text{D}} R_{\text{DS(on)max}}, I_{\text{D}}=30\text{ A}$ | 22  | 45   | -    | S                |

<sup>2)</sup> Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm<sup>2</sup> (one layer, 70  $\mu\text{m}$  thick) copper area for drain connection. PCB is vertical in still air.

<sup>3)</sup> See figure 3 for more detailed information

| Parameter | Symbol | Conditions | Values |      |      | Unit |
|-----------|--------|------------|--------|------|------|------|
|           |        |            | min.   | typ. | max. |      |

**Dynamic characteristics**

|                              |              |   |   |     |      |    |
|------------------------------|--------------|---|---|-----|------|----|
| Input capacitance            | $C_{iss}$    | $V_{GS}=0\text{ V}, V_{DS}=15\text{ V},$<br>$f=1\text{ MHz}$                    | - | 970 | 1300 | pF |
| Output capacitance           | $C_{oss}$    |   | - | 340 | 450  |    |
| Reverse transfer capacitance | $C_{rss}$    |   | - | 20  | -    |    |
| Turn-on delay time           | $t_{d(on)}$  | $V_{DD}=15\text{ V}, V_{GS}=10\text{ V},$<br>$I_D=30\text{ A}, R_G=1.6\ \Omega$ | - | 3.4 | -    | ns |
| Rise time                    | $t_r$        |   | - | 2.2 | -    |    |
| Turn-off delay time          | $t_{d(off)}$ |   | - | 13  | -    |    |
| Fall time                    | $t_f$        |   | - | 2.0 | -    |    |

**Gate Charge Characteristics<sup>5)</sup>**

|                              |               |   |   |     |     |    |
|------------------------------|---------------|---|---|-----|-----|----|
| Gate to source charge        | $Q_{gs}$      | $V_{DD}=15\text{ V}, I_D=30\text{ A},$<br>$V_{GS}=0\text{ to }4.5\text{ V}$ | - | 3.4 | 4.5 | nC |
| Gate charge at threshold     | $Q_{g(th)}$   |   | - | 1.5 | 2.1 |    |
| Gate to drain charge         | $Q_{gd}$      |   | - | 1.5 | 2.4 |    |
| Switching charge             | $Q_{sw}$      |   | - | 3.3 | 4.8 |    |
| Gate charge total            | $Q_g$         |   | - | 6.1 | 8   |    |
| Gate plateau voltage         | $V_{plateau}$ |   | - | 3.5 | -   |    |
| Gate charge total            | $Q_g$         | $V_{DD}=15\text{ V}, I_D=30\text{ A},$<br>$V_{GS}=0\text{ to }10\text{ V}$  | - | 13  | 17  | nC |
| Gate charge total, sync. FET | $Q_{g(sync)}$ | $V_{DS}=0.1\text{ V},$<br>$V_{GS}=0\text{ to }4.5\text{ V}$                 | - | 5.3 | 7.0 |    |
| Output charge                | $Q_{oss}$     | $V_{DD}=15\text{ V}, V_{GS}=0\text{ V}$                                     | - | 8.9 | 12  |    |

**Reverse Diode**

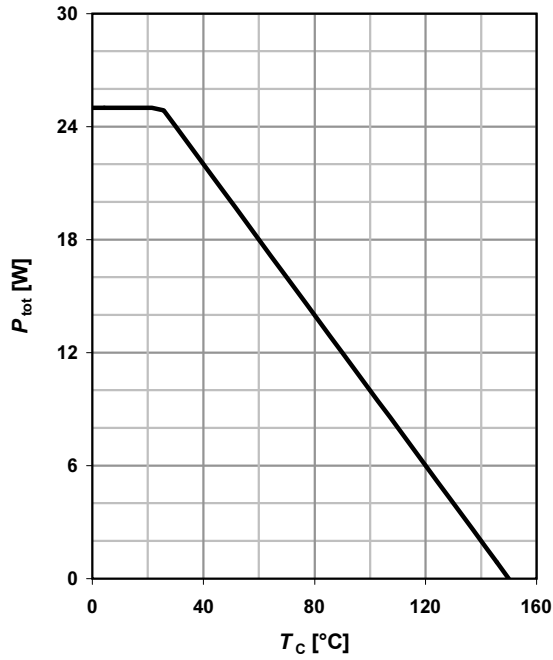
|                                  |               |   |   |     |     |    |
|----------------------------------|---------------|---|---|-----|-----|----|
| Diode continuous forward current | $I_S$         | $T_C=25\text{ }^\circ\text{C}$  | - | -   | 23  | A  |
| Diode pulse current              | $I_{S,pulse}$ |   | - | -   | 140 |    |
| Diode forward voltage            | $V_{SD}$      | $V_{GS}=0\text{ V}, I_F=20\text{ A},$<br>$T_j=25\text{ }^\circ\text{C}$ | - | 0.9 | 1.1 | V  |
| Reverse recovery charge          | $Q_{rr}$      | $V_R=15\text{ V}, I_F=I_S,$<br>$di_F/dt=400\text{ A}/\mu\text{s}$       | - | -   | 10  | nC |

<sup>4)</sup> See figure 13 for more detailed information

<sup>5)</sup> See figure 16 for gate charge parameter definition

**1 Power dissipation**

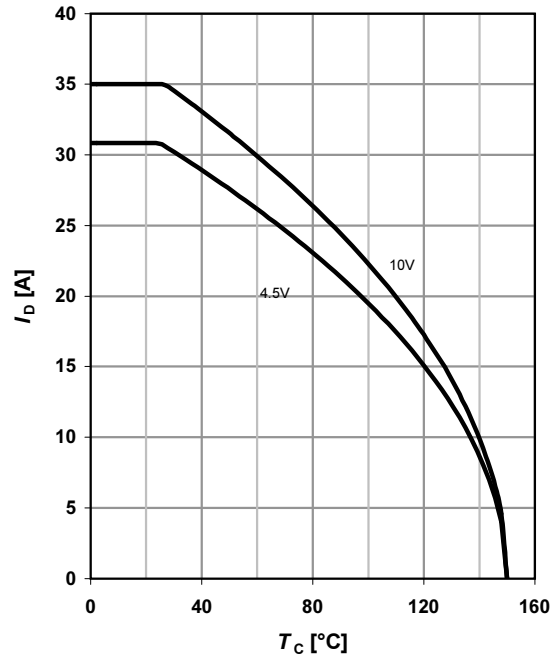
$P_{tot}=f(T_C)$



**2 Drain current**

$I_D=f(T_C)$

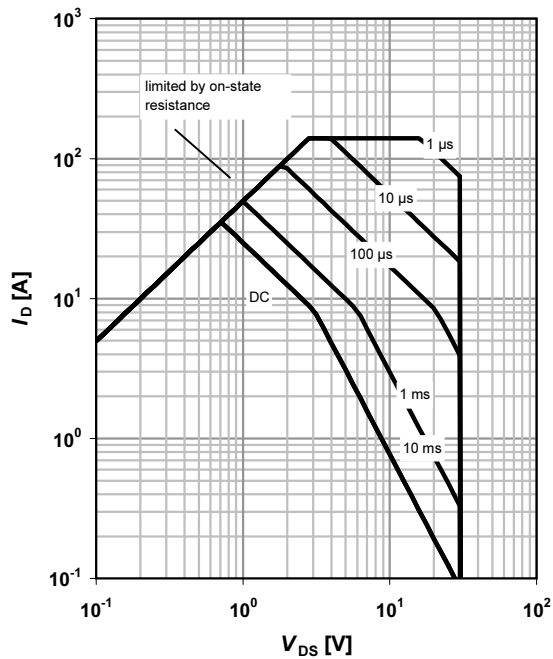
parameter:  $V_{GS}$



**3 Safe operating area**

$I_D=f(V_{DS}); T_C=25\text{ °C}; D=0$

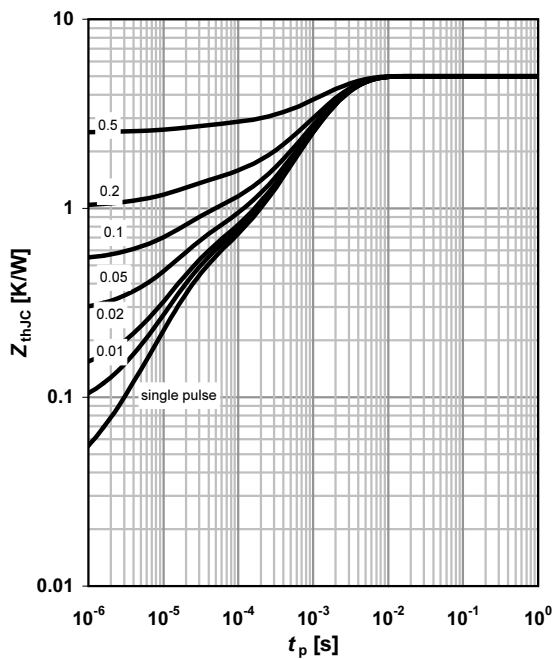
parameter:  $t_p$



**4 Max. transient thermal impedance**

$Z_{thJC}=f(t_p)$

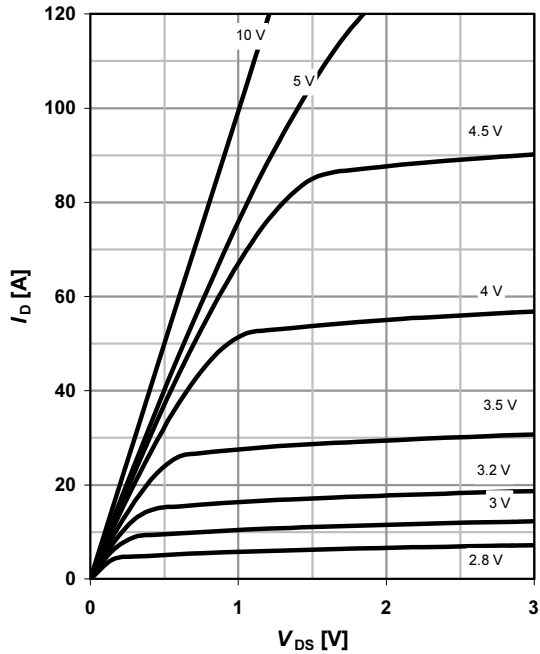
parameter:  $D=t_p/T$



**5 Typ. output characteristics**

$I_D = f(V_{DS}); T_j = 25\text{ °C}$

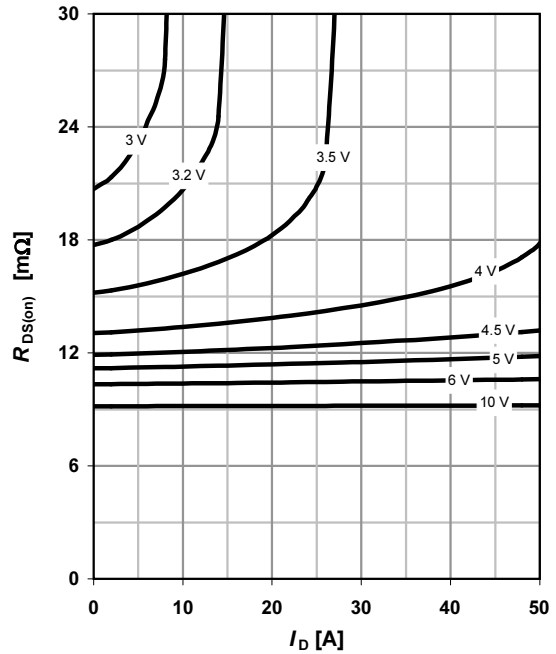
parameter:  $V_{GS}$



**6 Typ. drain-source on resistance**

$R_{DS(on)} = f(I_D); T_j = 25\text{ °C}$

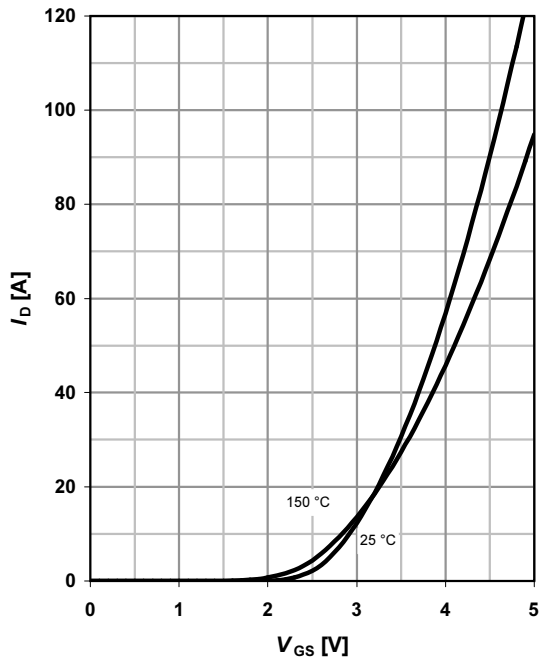
parameter:  $V_{GS}$



**7 Typ. transfer characteristics**

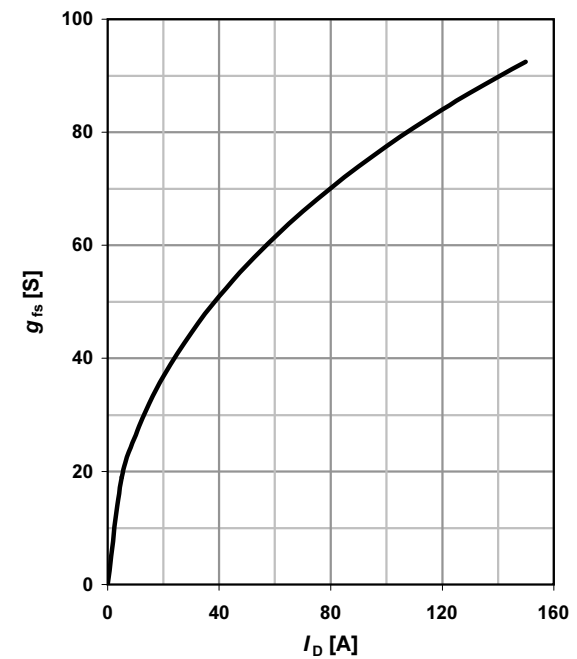
$I_D = f(V_{GS}); |V_{DS}| > 2|I_D|R_{DS(on)max}$

parameter:  $T_j$



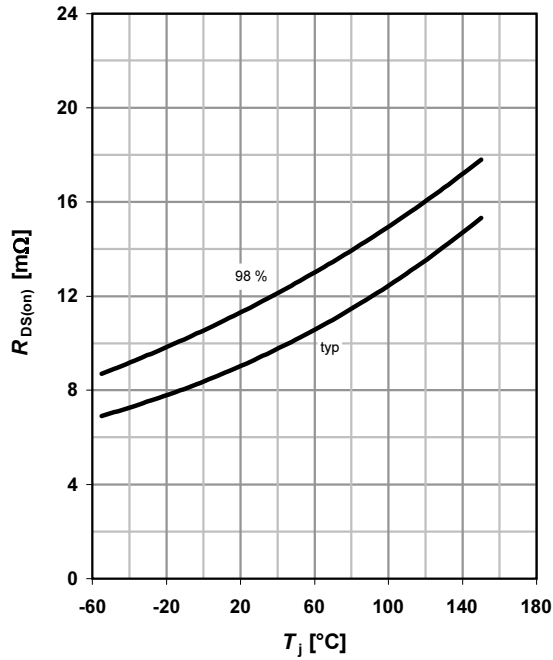
**8 Typ. forward transconductance**

$g_{fs} = f(I_D); T_j = 25\text{ °C}$

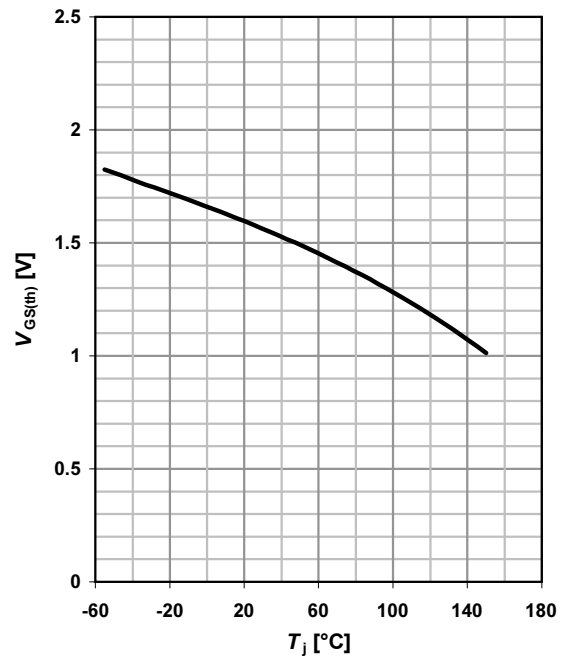


**9 Drain-source on-state resistance**

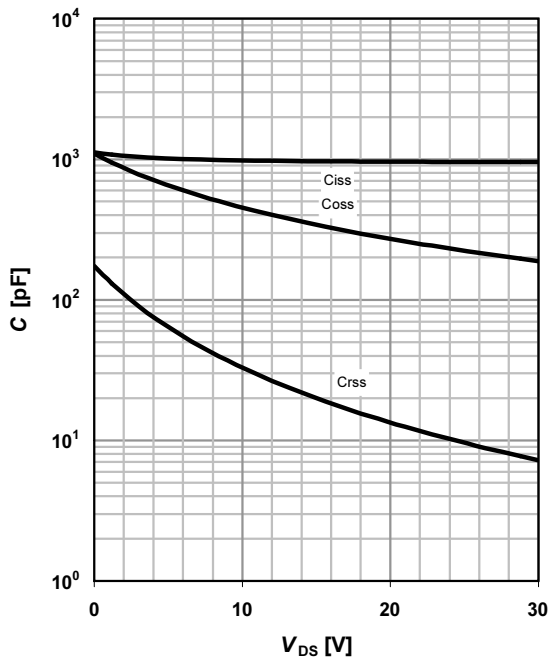
$$R_{DS(on)} = f(T_j); I_D = 20 \text{ A}; V_{GS} = 10 \text{ V}$$


**10 Typ. gate threshold voltage**

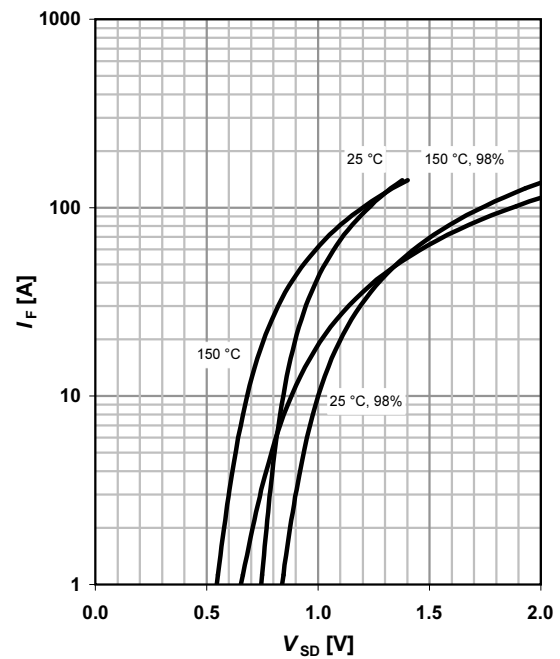
$$V_{GS(th)} = f(T_j); V_{GS} = V_{DS}; I_D = 250 \mu\text{A}$$


**11 Typ. capacitances**

$$C = f(V_{DS}); V_{GS} = 0 \text{ V}; f = 1 \text{ MHz}$$

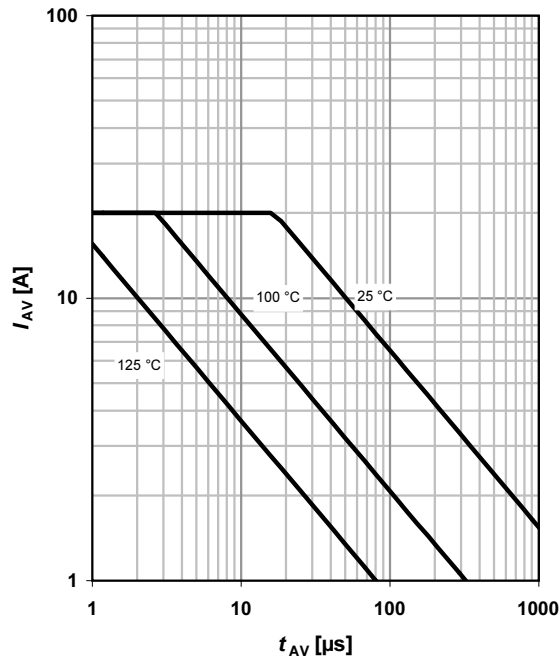

**12 Forward characteristics of reverse diode**

$$I_F = f(V_{SD})$$

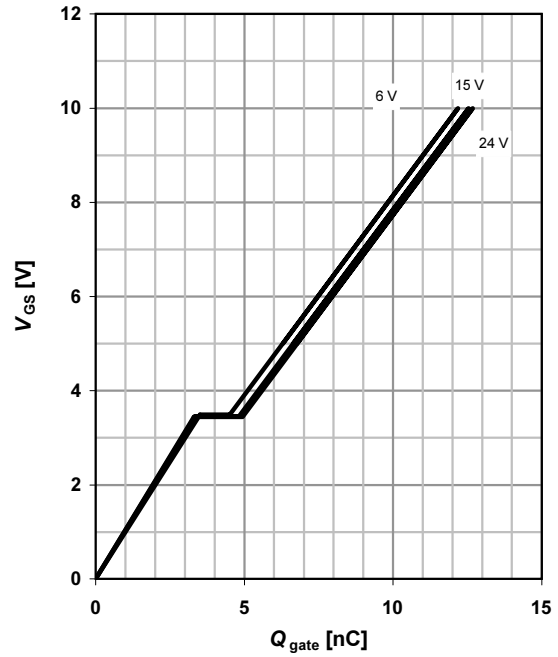
 parameter:  $T_j$ 


**13 Avalanche characteristics**

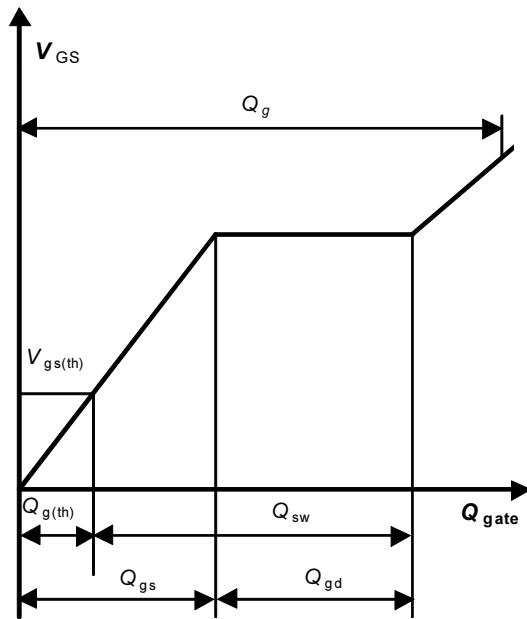
$$I_{AS} = f(t_{AV}); R_{GS} = 25 \Omega$$

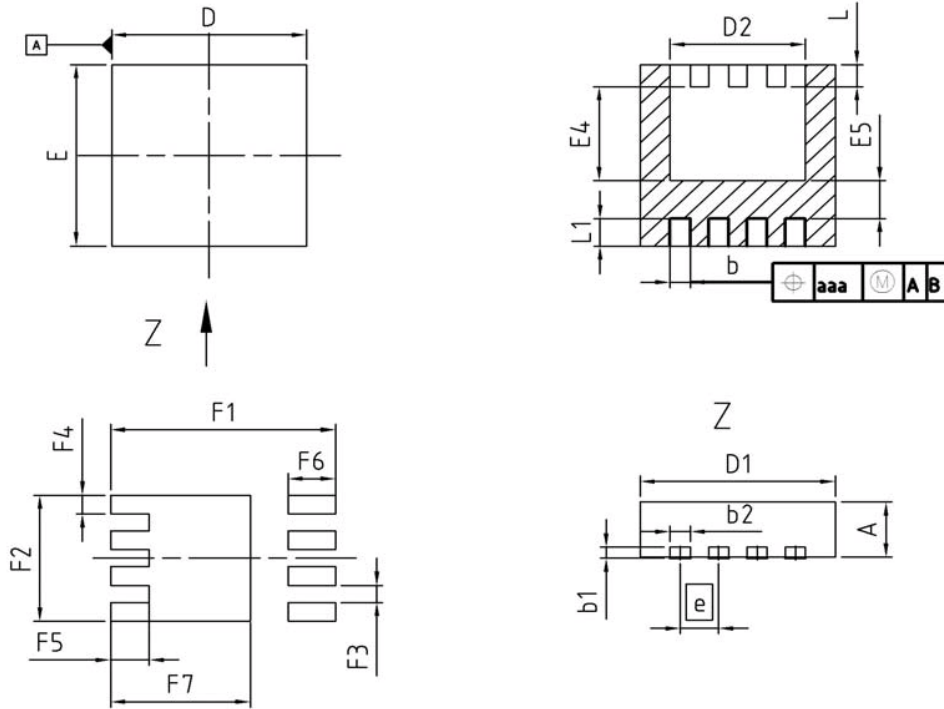
 parameter:  $T_{j(\text{start})}$ 

**14 Typ. gate charge**

$$V_{GS} = f(Q_{\text{gate}}); I_D = 30 \text{ A pulsed}$$

 parameter:  $V_{DD}$ 

**15 Drain-source breakdown voltage**

$$V_{BR(DSS)} = f(T_j); I_D = 1 \text{ mA}$$


**16 Gate charge waveforms**


**Package Outline**
**PG-TSDSON-8**


| DIM  | MILLIMETERS |      | INCHES |       |
|------|-------------|------|--------|-------|
|      | MIN         | MAX  | MIN    | MAX   |
| A    | 0.90        | 1.10 | 0.035  | 0.043 |
| b    | 0.24        | 0.44 | 0.009  | 0.017 |
| b1   | 0.10        | 0.30 | 0.004  | 0.012 |
| b2   | 0.20        | 0.44 | 0.008  | 0.017 |
| D=D1 | 3.20        | 3.40 | 0.126  | 0.134 |
| D2   | 2.15        | 2.45 | 0.085  | 0.096 |
| E    | 3.20        | 3.40 | 0.126  | 0.134 |
| E4   | 1.60        | 1.81 | 0.063  | 0.071 |
| E5   | 0.59        | 0.86 | 0.023  | 0.034 |
| e    | 0.65        |      | 0.026  |       |
| N    | 8           |      | 8      |       |
| L    | 0.30        | 0.56 | 0.012  | 0.022 |
| L1   | 0.33        | 0.60 | 0.013  | 0.024 |
| aaa  | 0.25        |      | 0.010  |       |
| F1   | 3.80        |      | 0.150  |       |
| F2   | 2.29        |      | 0.090  |       |
| F3   | 0.31        |      | 0.012  |       |
| F4   | 0.34        |      | 0.013  |       |
| F5   | 0.65        |      | 0.026  |       |
| F6   | 0.80        |      | 0.031  |       |
| F7   | 2.36        |      | 0.093  |       |

|                             |
|-----------------------------|
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| EUROPEAN PROJECTION<br>     |
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